

- **Designed for SDARS IF Receiver**
- **Low Insertion Loss**
- **5.0 X 7.0 mm Surface-Mount Case**
- **Differential or Single Ended Input and Output**
- **Complies with Directive 2011/65/EU (RoHS)**

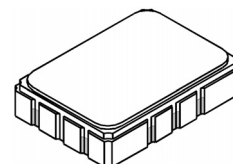


Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range (with tape & reel)	-40 to +85	°C
Storage Temperature Range (without tape & reel)	-50 to +125	°C
Max Soldering Profile	265°C for 10 s	

SF2039B-2

**72.540 MHz
SAW Filter**



SMP-03

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_c	1		72.540		MHz
Passband Insertion Loss	IL			10.5	12.5	dB
1dB Passband	BW ₁		3.7	4.0		MHz
15dB Bandwidth	BW ₁₅	1		6.5	6.7	MHz
30dB Bandwidth	BW ₃₀			7.5	7.7	MHz
Amplitude Ripple over $f_c \pm 1.85$ MHz				0.5	1.3	dB _{P-P}
Group Delay Variation over $f_c \pm 1.85$ MHz	GDV			60	150	ns _{P-P}
Rejection 50 to 66.48 MHz		1, 3	40	47		dB
66.48 to 68.08 MHz			30.5	43		
77.30 to 78.60 MHz			38	42		
78.60 to 86.50 MHz			40	44		
86.50 to 91.50 MHz			45	50		
91.50 to 100.00 MHz			45	55		
Operating Temperature Range	T _A	1	-40		+105	°C
Frequency Temperature Coefficient	FTC			-18		ppm/°C
Differential Input			175 ohms			
Differential Output			1000 ohms			
Case Style		6	SMP-03 7 x 5 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift) See note 4			RFM SF2039B YYWWS			

Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others



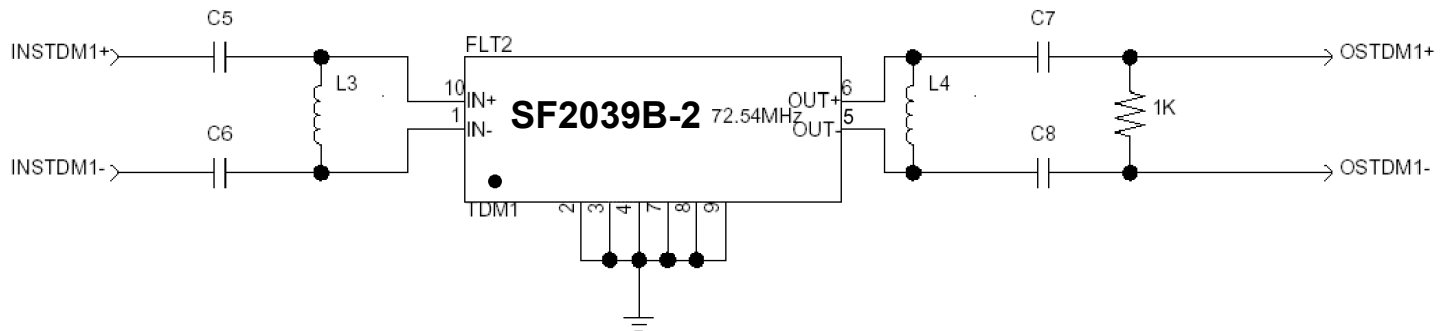
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

Matching Circuit and Matching Component Values Used in G3 Sirius Radios

(Refer to Sirius Radio G3 Chipset Application Note, Doc. #RX000104-B, Sec. 4.2.3)

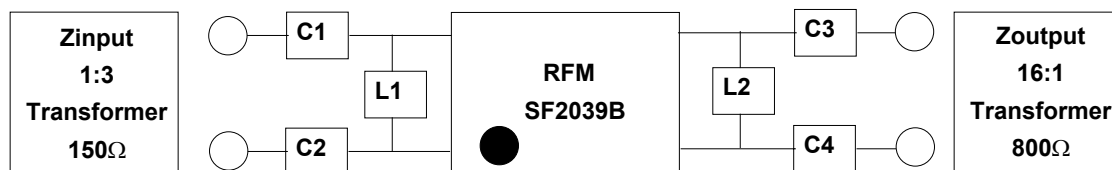


TDM1 Narrowband SAW Matching Circuit

TDM1 Narrowband SAW Matching Values

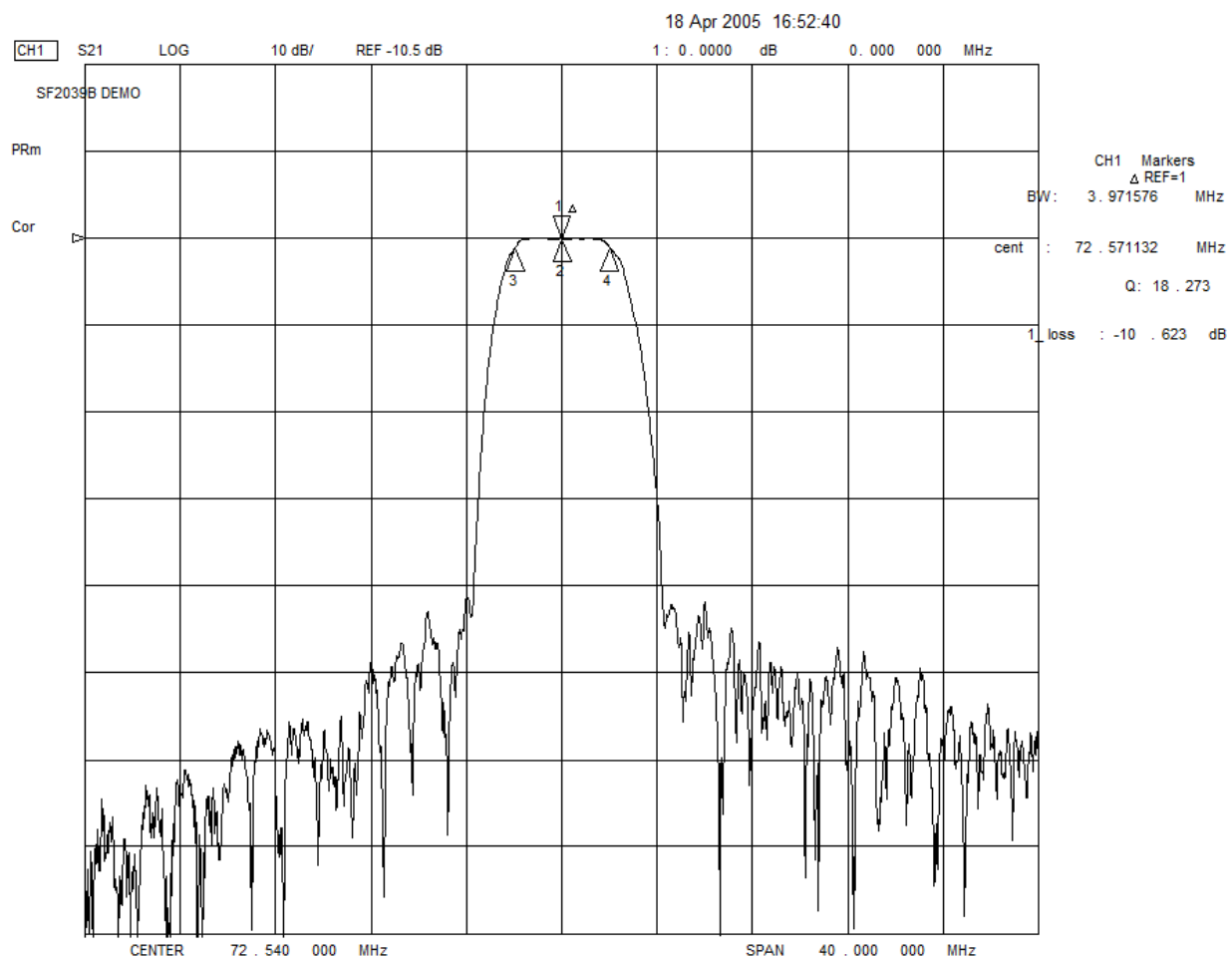
Reference Designator	Value
C5	10 pF
C6	10 pF
L3	330 nH
L4	560 nH
C7	100 pF
C8	100 pF

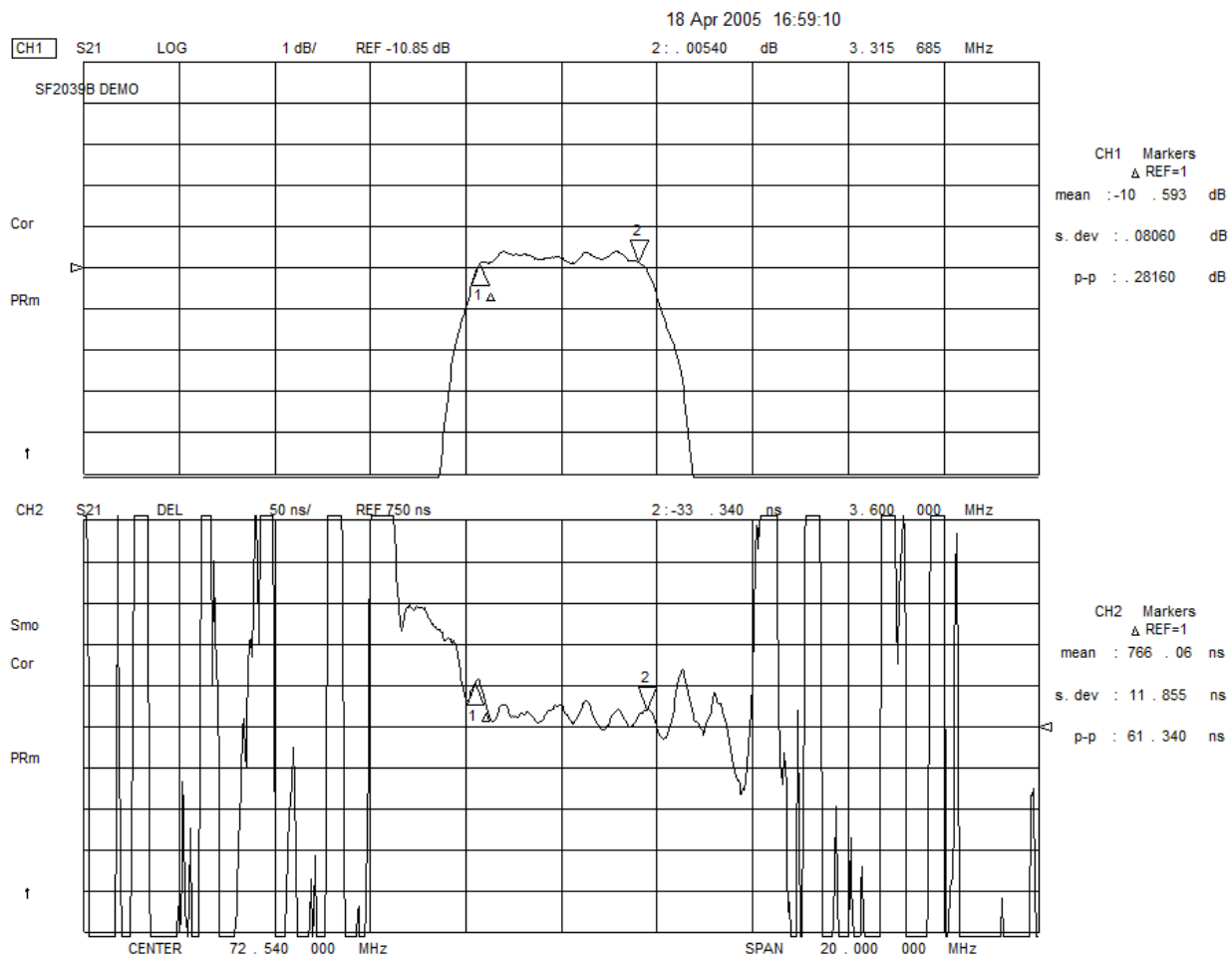
Matching Circuit and Matching Component Values Used on Filter Demo Board



SF2039B
72.540 MHz

C1 = 10pF
C2 = 10pF
L1 = 330nH
L2 = 390nH
C3 = 18pF
C4 = 18pF





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CH1 S11 1 UFS

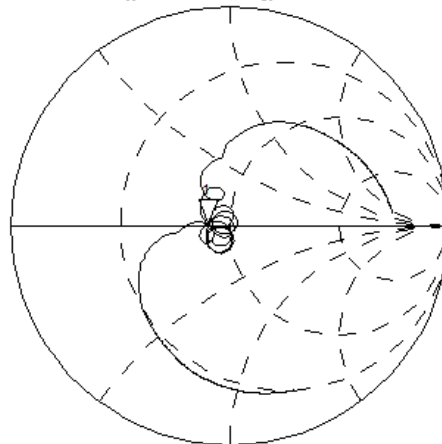
1: 41.178 Ω 0.9043 Ω 1.9840 nH 72.540 000 MHz

SF2039B DEMO

Cor

PRm

1



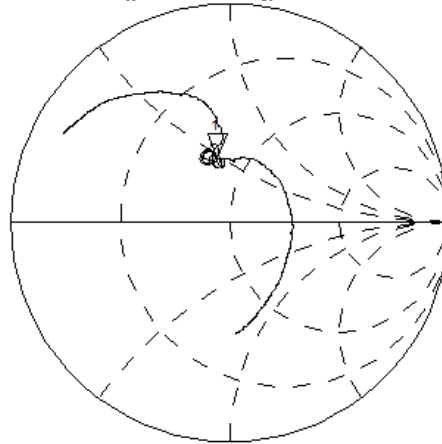
CH2 S22 1 UFS

1: 37.799 Ω 24.313 Ω 53.342 nH 72.540 000 MHz

Cor

PRm

1



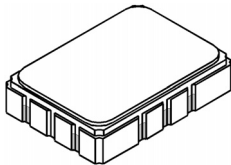
CENTER 72.540 000 MHz

SPAN 20.000 000 MHz

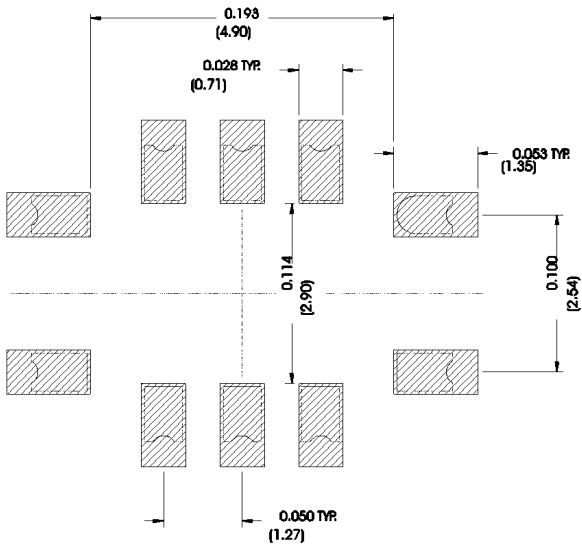
SMP-03 Case

10-Terminal Ceramic Surface-Mount Case

7 x 5 mm Nominal Footprint



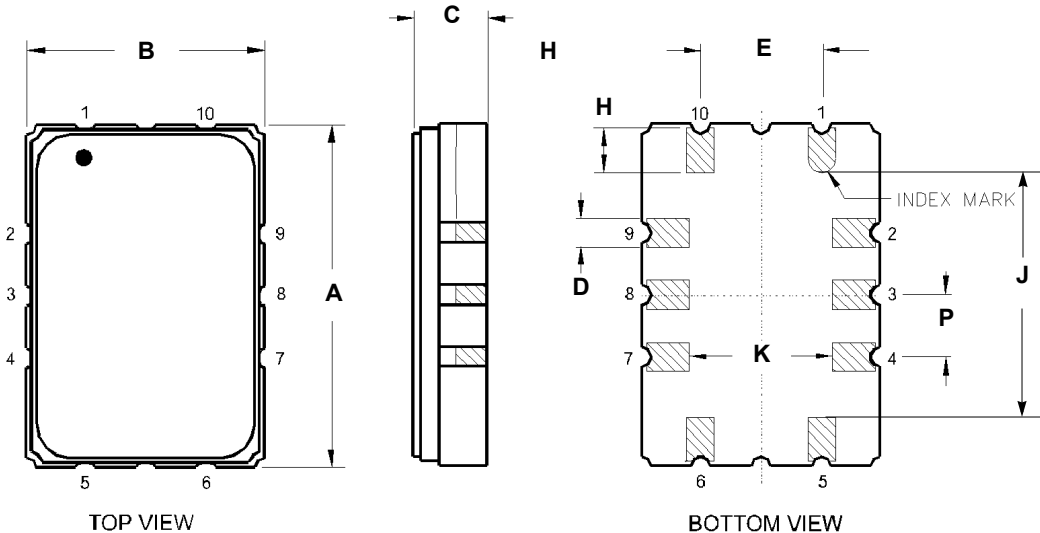
Recommended PCB Footprint



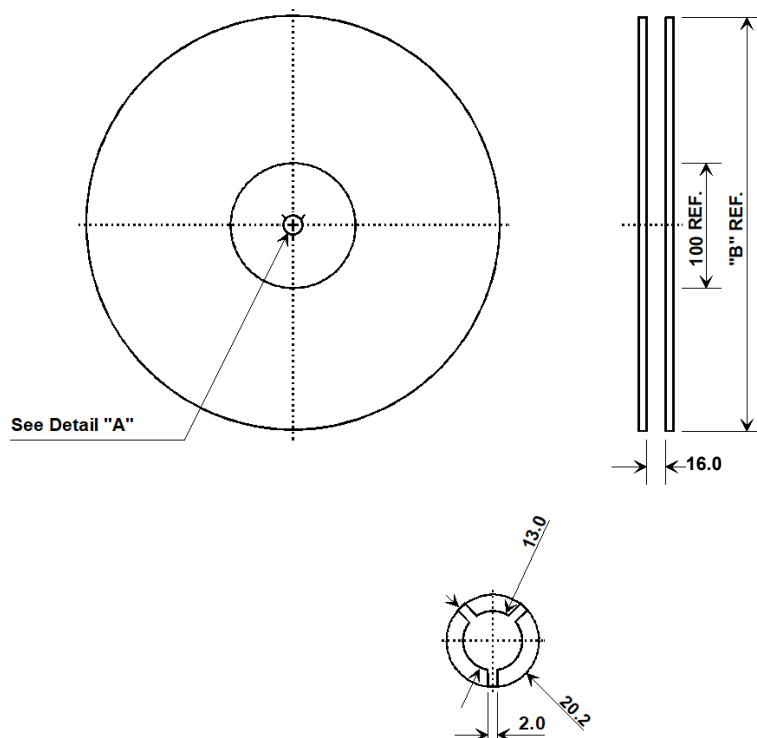
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

Materials	
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick
Body	Al ₂ O ₃ Ceramic
Pb Free	

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot



Tape and Reel Specifications



"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

Product Reflow/ESD/MSL

Reflow Peak Temperature	265	°C
Reflow Peak Time	10	Seconds
Liquidus 217 Temperature/Time	110	Seconds
Over Liquidus 230 Temperature/Time	70	Seconds
Reflow Condition	SMT	
Class Level HBM	2	
HBM(V)	2000	HBM(V)
MM(V)	N/A	MM(V)
CDM(V)	2000	CDM(V)
MSL	1	

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm

